SAMSUNG ELECTRO-MECHANICS

RoHS+Halogen Compliant ecoparts

SPECIFICATION

- **Supplier : Samsung electro-mechanics**
- **Product : Multi-layer Ceramic Capacitor**
- **Samsung P/N : CL21F106ZQFNNNG**
- **Descriptiont : CAP,10㎌, -20+80%, 6.3V, Y5V, 0805**

A. Samsung Part Number

CL	21	F	106	Z	Q	F	N	N	N	G
①	②	③	④	⑤	⑥	⑦	⑧	⑨	⑩	⑪

①	**Series**	Samsung Multi-layer Ceramic Capacitor			
②	**Size**	0805 (inch code)	L: 2.0 ± 0.1 mm	W: 1.25 ± 0.1 mm	
③	**Dielectric**	Y5V	⑧	**Inner electrode**	Ni
④	**Capacitance**	10 ㎌		**Termination**	Cu
⑤	**Capacitance tolerance**	-20/+80 %		**Plating**	Sn 100% (Pb Free)
			⑨	**Product**	Normal
⑥	**Rated Voltage**	6.3 V	⑩	**Special**	Reserved for future use
⑦	**Thickness**	1.25 ± 0.1 mm	⑪	**Packaging**	Embossed Type, 7" reel(3000ea)

B. Samsung Reliablility Test and Judgement condition

	Performance	Test condition
Capacitance	Within specified tolerance	1㎑±10% 1.0±0.2Vrms
Tan δ (DF)	0.16 max.	
Insulation Resistance	10,000Mohm or 100Mohm·㎌ Whichever is Smaller	Rated Voltage 60~120 sec.
Appearance	No abnormal exterior appearance	Microscope (×10)
Withstanding Voltage	No dielectric breakdown or mechanical breakdown	250% of the rated voltage
Temperature Characterisitcs	Y5V (From -30℃ to 85℃, Capacitance change shoud be within -82~+22%)	
Adhesive Strength of Termination	No peeling shall be occur on the terminal electrode	500g·F, for 10±1 sec.
Bending Strength	Capacitance change : within ±30%	Bending to the limit (1mm) with 1.0mm/sec.
Solderability	More than 75% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5℃, 3±0.3sec. (preheating : 80~120℃ for 10~30sec.)
Resistance to Soldering heat	Capacitance change : within ±20% Tan δ, IR : initial spec.	Solder pot : 270±5℃, 10±1sec.

	Performance	Test condition
Vibration Test	Capacitance change : within ±20% Tan δ, IR : initial spec.	Amplitude : 1.5mm From 10㎐ to 55㎐ (return : 1min.) 2hours × 3 direction (x, y, z)
Moisture Resistance	Capacitance change : within ±30% Tan δ : 0.195 max IR : 12.5㏁·㎌ or Over	With rated voltage 40±2℃, 90~95%RH, 500+12/-0hrs
High Temperature Resistance	Capacitance change : within ±30% Tan δ : 0.195 max IR : 25㏁·㎌ or Over	With 150% of the rated voltage Max. operating temperature 1000+48/-0hrs
Temperature Cycling	Capacitance change : within ±20% Tan δ, IR : initial spec.	1 cycle condition Min. operating temperature → 25℃ → Max. operating temperature → 25℃ 5 cycle test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5℃, 10sec. Max)

* For the more detail Specification, Please refer to the Samsung MLCC catalogue.